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Electronic conduction and superconducting properties of $CoSi_2$ films on silicon – an unconventional superconductor with technological potential

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We report observations of unusual normal-state electronic conduction properties and superconducting characteristics of high-quality CoSi_2/Si films grown on silicon Si(100) and Si(111) substrates. A good understanding of these features shall help to address the underlying physics of the unconventional pairing symmetry recently observed in transparent $\text{CoSi}_2/\text{TiSi}_2$ heterojunctions [S. P. Chiu *et al.*, Sci. Adv. 7, eabg6569 (2021); Nanoscale 15, 9179 (2023)], where CoSi_2/Si is a superconductor with a superconducting transition temperature $T_c \simeq (1.1-1.5)$ K, dependent on its dimensions, and TiSi₂ is a normal metal. In CoSi_2/Si films, we find a pronounced positive magnetoresistance caused by the weak-antilocalization effect, indicating a strong Rashba spin-orbit coupling (SOC). This SOC generates two-component superconductivity in $\text{CoSi}_2/\text{TiSi}_2$ heterojunctions. The CoSi_2/Si films are stable under ambient conditions and have ultralow 1/fnoise. Moreover, they can be patterned via the standard lithography techniques, which might be of considerable practical value for future scalable superconducting and quantum device fabrication.

Keywords: Cobalt-disilicide films on silicon, electronic conduction properties, Rashba spin-orbit coupling, low-frequency noise, spin-triplet superconductivity, superconducting and quantum devices

I. INTRODUCTION

The physics of unconventional superconducting states has been front and center of recent theoretical and experimental condensed matter research [1–4]. Both scientific interest and potential technological prospects drive this development. Recently, through phase-sensitive conductance spectroscopy studies of the "anomalous proximity effect" [5, 6], we have found that the Cooper pairing characteristics in nonmagnetic CoSi₂/TiSi₂ superconductor/normal metal heterojunctions point to spin-triplet pairing symmetry [7, 8], where CoSi₂ is a superconductor (S) with an optimal superconducting transition temperature $T_c \approx 1.55$ K, and TiSi₂ is a normal metal (N) down to at least 50 mK. More precisely, in the vicinity of the high-transmittance CoSi₂/TiSi₂ S/N interface, the pair function has a dominant even-frequency spintriplet odd- parity p-wave component in $CoSi_2/Si$. In contrast, it has an odd-frequency spin-triplet even-parity s-wave component in TiSi₂. Our S/N heterojunctions were grown on silicon Si(100) or Si(111) substrates. The device fabrication method has been described elsewhere [9] and is briefly summarized in Section II. Because the unusual physical properties arise from the thin-film form of $CoSi_2$ on silicon, we shall denote our films by $CoSi_2/Si$ in this paper. We emphasize that the unconventional nature of the superconductivity observed in Refs. [7] and [8] is only pertinent to S/N junctions made of $CoSi_2/Si$ films. Bulk (poly- or single-crystalline) CoSi₂ is a conventional BCS s-wave superconductor. The pairing in bulk CoSi₂ is mediated by the electron-phonon interaction [10], with an electron-phonon coupling constant $\lambda \simeq$ 0.44 and a renormalized Coulomb pseudopotential between electrons $\mu^* \simeq 0.13$ [11].

The conductance spectra of two-terminal S/N junctions [a schematic is provided in Fig. 1(a)] and threeterminal so-called T-shaped superconducting proximity structures [12], schematically depicted in Fig. 1(c), are both phase sensitive to the pairing symmetry of the S component. These two kinds of hetero-devices can provide independent and complementary information to discriminate an unconventional superconductor from a conventional one. In the T-shaped proximity structure, the S is attached through an N arm and located a short distance (on the order of the superconducting coherence length) away from the normal-metal wire N. Extensive theoretical calculations have been conducted by Tanaka et al. [13] and Asano et al. [12] who concluded that Tshaped superconducting proximity structures act as diagnostic tools for *p*-wave pairing. The main panel of Fig. 1(a) depicts that for a S/N junction, the differential conductance, defined by G(V,T) = dI(V,T)/dV, features a familiar zero-bias conductance dip for a spin-singlet swave S component, where I is the current, V is the bias voltage, and T is the temperature. In sharp contrast, the theory predicts a broad zero-bias conductance peak (ZBCP) accompanied by two symmetric side dips for a spin-triplet p-wave pairing S component. The two side

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FIG. 1. Conductance spectra of S/N heterojunctions and T-shaped superconducting proximity structures. (a) Schematic normalized conductance spectra $(dI/dV)_n$ for a S/N junction of barrier strength $\tilde{Z} = 1$ with a s-wave (blue) and chiral p-wave (red) pairing S component [14, 15]. Inset: A schematic $\text{CoSi}_2/\text{TiSi}_2$ S/N heterojunction on a silicon substrate with a 4-probe configuration. (b) $(dI/dV)_n$ versus eV/Δ_0 for two representative $\text{CoSi}_2/\text{TiSi}_2$ S/N heterojunctions manifesting p-wave pairing (taken from [7]). (c) Left: A schematic T-shaped superconducting proximity structure with a 4-probe configuration. Right: Schematic conductance spectra of a T-shaped proximity device with a spin-triplet (top) and spin-singlet (bottom) S component. (d) $(dI/dV)_n$ versus eV/Δ_0 for two $\text{CoSi}_2/\text{TiSi}_2$ T-shaped proximity devices manifesting spin-triplet pairing (device A1 taken from [7]). In (b) and (d), the $(dI/dV)_n$ curves were measured at T = 0.37 K and in zero magnetic field. They are vertically offset for clarity.

dips signify the superconducting energy gap, $\triangle(T)$. Furthermore, for the T-shaped proximity structure where G(V) curves are measured along the N wire [cf. Fig. 1(c)], the theory predicts a zero-bias conductance dip for a spin-singlet S component, while it predicts a ZBCP for

a spin-triplet S component. The width of the ZBCP in this case is small, being on the order of the Thouless energy $E_{\rm Th} \ [\ll \Delta_0 = \Delta(T \to 0)]$. Consequently, conductance spectroscopy studies can be a powerful probe for distinguishing the *p*-wave from conventional *s*-wave pairing symmetry in the S component.

Experimentally, it is challenging to fabricate S/N junctions and T-shaped proximity devices with a clean S/N interface so that the Andreev reflection can occur [16]. Figures 1(b) and 1(d) respectively show the normalized $(dI/dV)_n$ curves versus eV/Δ_0 for two CoSi₂/TiSi₂ S/N

junctions and two T-shaped proximity devices which we have recently measured [7], where $(dI/dV)_n$ is the G(V) normalized to its corresponding normal-state value, defined by $(dI/dV)_n = [dI(V,T)/dV]/[dI(V,T=4 \text{ K})/dV]$, and e is the electronic charge. In both cases, the line

shape of our conductance spectra conforms to the spintriplet pairing symmetry. This is a very encouraging observation because the spin-triplet pairing symmetry is nontrivial to realize in real materials [2, 3]. Among elemental metals, metal alloys and compound superconductors, besides He^3 [17], triplet pairing has only been found in a limited number of materials, including UTe₂, URhGe, UPt_3 and UBe_{13} [3], while two-component superconductivity exists in MnSi, some heavy fermion compounds, and other non-inversion symmetric superconductors [18–21]. Two-component nematic superconductivity in 4Hb-TaS₂ has been reported recently [22]. In Fig. 1(b), the central narrow peak on top of the broad hump is an extraordinary feature compatible with expectations for chiral *p*-wave pairing, which becomes more pronounced when a thin regime in the N component adjacent to the S/N interface has a high resistance relative to the junction resistance [6]. Apart from the conductance spectra, our measurements of the magnetoresistance (MR) of small S/N junctions manifest unusual "advanced" hysteresis in low magnetic fields (not shown), a phenomenon likely arising from net spontaneous supercurrents associated with chiral *p*-wave domains [7]. This unusual signature provides further evidence for an unconventional superconducting state in CoSi₂/TiSi₂ heterojunctions.

This paper reports the normal-state electronic conduction properties and superconducting characteristics for a series of $CoSi_2/Si$ films with thickness (t) ranging from 5 to 315 nm. A thorough understanding of this intriguing thin-film material's fundamental transport features may help unravel the microscopic origin(s) for the unconventional superconductivity found in CoSi₂/TiSi₂ heterojunctions. In addition, because our junction fabrication processes are fully compatible with the present-date silicon-based integrated circuit (IC) technology, microfabrication and scalability of CoSi₂/Si-based superconducting circuits should be feasible. Thus, it is desirable to study the t dependence of the transport and superconducting properties to understand which t range would be most relevant and suitable for potential quantumtechnology applications. For comparison and completeness, we have also fabricated several TiSi₂/Si films and several NiSi₂/Si films and studied their transport characteristics. These two disilicides are normal metals. They have much weaker spin-orbit coupling (SOC) than that in CoSi₂/Si films.

This paper is organized as follows. Section II contains our experimental methods for sample fabrication and electrical transport measurements. Section III includes the electronic conduction properties, including measurements of spin-orbit scattering time and the electron dephasing time. The low-frequency 1/f noise in the normal state is presented. The transport properties of TiSi₂/Si films and NiSi₂/Si films are also studied for comparison. Section IV discusses the variation of superconduct-



FIG. 2. Structure characterizations of CoSi_2/Si films annealed at 800°C. (a) GIXRD spectra for three as-grown 105nm thick CoSi_2/Si films. The films were annealed for 30 or 90 min. (b) Cross-sectional TEM image for a 90-min annealed $\text{CoSi}_2/\text{Si}(100)$ film. The arrows indicate grain boundaries. (c) Zoom-in image of atomically sharp $\text{CoSi}_2/\text{Si}(100)$ interface. Left top and bottom insets: TEM diffraction patterns for CoSi_2 and Si(100), respectively. They reveal the epitaxial relation of $\text{CoSi}_2(100)$ on Si(100) from the information: $\text{CoSi}_2[011] // \text{Si}[011]$ and $\text{CoSi}_2(200) // \text{Si}(200)$.

ing properties with t, and estimates the superconducting coherence length and penetration depth. Our conclusion is given in section V.

II. EXPERIMENTAL METHOD

A. Growth of Disilicide films

Growth of CoSi₂/Si films. A thin Co layer of thickness $t_{\rm Co}$ was deposited on a high-purity Si(100) substrate or a Si(111) substrate via thermal evaporation. The 99.998% purity Co wire was supplied by Alfa Aesar Corporation. Intrinsic (*i.e.*, nominally undoped) Si wafers with $\rho(300 \,\mathrm{K}) > 20000 \,\Omega$ cm were made by the floating zone method and supplied by Summit-tech corporation. A mechanical mask was used to define the sample geometry. In some cases, the electron-beam lithography and lift-off technique was utilized to make small patterns. The deposited Co on silicon was thermally annealed at several hundred degrees °C and for a few hours in a high vacuum ($\approx 3 \times 10^{-6}$ Torr) to achieve the desired CoSi₂ phase. The final thickness of the single-phased CoSi₂/Si film was previously empirically established to be $t \simeq 3.5 t_{\rm Co}$ [23, 24]. The optimal annealing temperature (T_A) to form the stoichiometric CoSi₂ phase with minimal agglomeration ranged from 550°C to 800°C. The thinner the as-deposited $t_{\rm Co}$ was, the lower the optimal T_A value preferred. The duration time for annealing at the optimal T_A temperature typically ranged from 0.5 to 2 h.

Due to the minor lattice mismatch ($\approx -1.2\%$) of CoSi₂ to Si, epitaxial phases of CoSi₂ on the Si(100) or Si(111) substrate were readily formed under proper thermal annealing conditions. The grazing incidence X-ray diffraction (GIXRD) spectra for three as-grown 105-nm thick CoSi₂/Si films are plotted in Fig 2(a). The spectra reveal the preferred lattice orientations of (111), (220), and (311), confirming the formation of the CoSi₂ phase on silicon. The 30-min annealed film has a barely visible (311) peak, reflecting an insufficient annealing time period.

Figure 2(b) shows the cross-sectional transmission electron microscopy (TEM) image for a ≈ 100 -nm thick CoSi₂ film on Si(100). The two arrows indicate the grain boundaries of a CoSi₂ grain with a lateral size of ≈ 400 nm. Figure 2(c) shows a high-resolution TEM image demonstrating the epitaxy of CoSi₂(100) on Si(100). It clearly reveals that CoSi₂ and Si form a sharp and strainfree metal-semiconductor interface. Two kinds of epitaxial relations often compete in the CoSi₂/Si(100) system, namely, the epitaxy of CoSi₂(100) on Si(100) and the epitaxy of CoSi₂(110) on Si(100), as previously established [25, 26] and discussed elsewhere [27].

Growth of TiSi₂/Si and NiSi₂/Si films. Using similar growth processes, we have also fabricated a series of TiSi₂/Si films and a series of NiSi₂/Si films and measured their electrical transport properties. In particular, we have utilized TiSi₂ for the *in situ* fabrication of $CoSi_2/TiSi_2$ heterojunctions to achieve high S/N interface transmittance, which is required for studying the conductance spectra arising from the Andreev reflection [14]. We find that TiSi₂/Si films have resistivity values similar to those of $CoSi_2/Si$ films. On the other hand, NiSi₂/Si films are much more disordered. Their spinorbit scattering time is measured and compared with that in $CoSi_2/Si$ films.

The deposition and thermal annealing processes for the growth of TiSi₂/Si films and NiSi₂/Si films were similar to those for the fabrication of $CoSi_2/Si$ films. The as-deposited Ti (Ni) films were annealed at 800°C for 1 h in a high vacuum ($\approx 3 \times 10^{-6}$ Torr) to form the C54 phase $TiSi_2$ (NiSi₂) on silicon. The lattice structure of NiSi₂ is identical to that of CoSi₂, namely, a centrosymmetric face-centered cubic (fcc) fluorite structure with -0.3% lattice mismatch to Si [28]. Thus, NiSi₂ can easily form epitaxy on Si. The C54 phase $TiSi_2$ has a facecentered orthorhombic structure which consists of recursion of four-layer stacking [29]. The $TiSi_2/Si$ films are polycrystalline, with an average grain size much smaller than that in $CoSi_2/Si$ films. [We note that in addition to the low-resistivity C54 phase $TiSi_2$, there exists a C49 phase TiSi₂, which has a smaller grain size than that in the C54 phase. The resistivity of the C49 phase is much higher, with the residual resistivity $\rho_0(C49) \sim 100 \ \mu\Omega \ cm$ $\gg \rho_0(C54)$ [8, 30]. In this work, we shall focus on the C54 phase.]

B. Electrical-transport measurements

In all cases, the electrical transport measurements were carried out employing the standard four-probe technique. Linear Research Model LR400 and LR-700 ac resistance bridges were used. They supplied a low-level signal operating at 16 Hz for measuring sample resistance while avoiding electron overheating at low temperatures (T). An Oxford Heliox ³He cryostat equipped with a 2-T NbTi superconducting magnet or a standard ⁴He cryostat provided the low-T environment. Several TiSi₂/Si films were measured in a BlueFors Model LD400 dilution refrigerator down to 50 mK.

III. NORMAL-STATE ELECTRONIC CONDUCTION PROPERTIES

In this section, we discuss the electrical-transport properties from resistivity $\rho(T)$ and the Hall effect measurements, relevant electronic parameters calculated from the measured residual resistivity (ρ_0) and carrier concentration (n), the spin-orbit scattering time (τ_{so}) and electron dephasing length (L_{φ}) extracted from the weak-antilocalization (WAL) measurements, and lowfrequency 1/f noise in CoSi₂/Si films are discussed. The conduction properties of TiSi₂/Si films and NiSi₂/Si films are also measured and discussed for comparison where appropriate.

A. Electronic conduction properties

Temperature dependence of resistivity. The electrical-transport properties of $CoSi_2/Si(100)$ films and CoSi₂/Si(111) films reveal typical Boltzmann transport behavior. As T decreases from room temperature, ρ decreases with decreasing T, reaching a residual resistivity, $\rho_0 \equiv \rho(4 \,\mathrm{K})$, before the film undergoes a sharp superconducting transition. Figure 3(a) shows the $\rho(T)$ curves for three $\text{CoSi}_2/\text{Si}(111)$ films, with t = 10.5, 35 and 105 nm, as indicated. Figure 3(b) shows the $\rho(T)$ curves below 1.8 K for five $CoSi_2/Si(100)$ films. Each film becomes superconducting at a temperature between ≈ 1.25 and 1.52 K, depending on t. The ρ_0 values of our thickest films are compatible with those of CoSi₂ single crystals [31] and arc-melted bulk $CoSi_2$ (see below). For our highest quality films, the superconducting transition width, ΔT_c , is as small as ≈ 5 mK. In most cases, $\Delta T_c \lesssim 15$ mK can be achieved if the thermal annealing conditions are optimized. Here ΔT_c is the temperature difference between the temperature where ρ drops to $0.9\rho_0$ and the temperature where ρ drops to $0.1\rho_0$.



FIG. 3. Variation of resistivity with temperature for CoSi_2/Si films. (a) ρ versus T for three $\text{CoSi}_2/\text{Si}(111)$ films with different t values. (b) ρ versus T for five $\text{CoSi}_2/\text{Si}(100)$ films below 1.8 K. (c) Room temperature resistivity $\rho_{300\text{K}}$ and residual resistivity ρ_0 versus $\log(t)$ for a series of $\text{CoSi}_2/\text{Si}(100)$ films and a series of $\text{CoSi}_2/\text{Si}(111)$ films, as indicated.

Our results of metallic $\rho(T)$ characteristics align with theoretical studies of the electronic conduction properties of CoSi₂. Band structure calculations indicate that the CoSi₂ Fermi surface is relatively simple, consisting of three nested hole sheets centered at the Brillouin-zone origin. The broad low-lying Si 3s-3p bands merge with the narrow Co 3d bands to form the CoSi₂ Fermi surface [32]. Theoretical analysis also demonstrates that the measured $\rho(T)$ curve agrees reasonably well with a Bloch-Grüneisen fit [11].

Residual resistivity versus film thickness t. The residual resistivity ρ_0 of $\text{CoSi}_2/\text{Si}(100)$ films and a series of CoSi₂/Si(111) films have been measured and compared. Figure 3(c) shows the variation of the room temperature resistivity (ρ_{300K}) and ρ_0 with $\log(t)$. For the thickest film (t = 315 nm) fabricated, a very low value of $\rho_0 = 1.77 \ \mu\Omega$ cm was obtained. This resistivity value is even lower than those of many elementary metals and metal alloys [33], indicating one of the beneficial conduction attributes of $CoSi_2/Si$ films. For example, these films can be used as interconnects in ICs [24]. As t decreases, ρ_0 progressively increases, as expected, due to increasing (partial specular) surface/interface scattering. For the films with $t \approx 7$ nm, $\rho_0 \simeq 17$ and $11 \ \mu\Omega$ cm for $CoSi_2/Si(100)$ and $CoSi_2/Si(111)$ films, respectively. For $t \gtrsim 10$ nm, the $\rho_0(t)$ values are approximately the same for both series of films. Close inspection indicates that systematically, $CoSi_2/Si(111)$ films have slightly lower $\rho_0(t)$ values than $\text{CoSi}_2/\text{Si}(100)$ films. Such information about the $\rho_0(t)$ variation will be useful for the design of, e.g., $CoSi_2/Si$ superconducting microwave resonators with desirable geometric inductance and kinetic inductance [34].

Hall effect and classical magnetoresistance. The

responsible carrier type and carrier concentration n have been determined through the Hall effect measurements at liquid-helium temperatures and above T_c . The charge carriers in CoSi_2/Si films are found to be holes rather than electrons, in consistency with the band structure calculations [32, 35]. Based on the free-electron gas model and assuming a single band, we obtain an average value $n \simeq (2.1 \pm 0.3) \times 10^{28} \text{ m}^{-3}$ for all films, independent of t and the substrate orientation Si(100) or Si(111). With the values of ρ_0 and *n* obtained, the elastic carrier/electron mean free time, $\tau_e = m^*/(ne^2\rho_0)$, for a given film can be calculated, by taking the effective carrier mass (m^*) to be the free electron mass (m_e) [35]. From the *n* value, the Fermi wavenumber $k_F = (3\pi^2 n)^{1/3} \approx 9 \times 10^9 \text{ m}^{-1}$ and the Fermi velocity $v_F = \hbar k_F / m^* \approx 1 \times 10^6$ m/s can be calculated, where \hbar is the reduced Planck constant. In practice, we obtain $\rho_0 l_e = 3\pi^2 \hbar/k_F^2 e^2 \approx 1.6 \times 10^{-15} \ \Omega \ \mathrm{m}^2$ for $\mathrm{CoSi}_2/\mathrm{Si}$ films, where $l_e = v_F \tau_e$ is the elastic carrier/electron mean free path. For example, for a $\rho_0 = 5 \ \mu\Omega$ cm CoSi₂/Si film, $\tau_e \simeq 3.4 \times 10^{-14}$ s, $l_e \simeq 34$ nm, the product $k_F l_e \simeq 300$, and the electron diffusion constant $D = v_F^2 \tau_e/3 \simeq 110$ $\rm cm^2/s$. Thus, these films fall in the weakly disordered regime where the quantum-interference phenomena, such as the weak-(anti)localization effect and universal conductance fluctuations [31, 36], should occur in the normal state at low T.

The classical MR due to the Lorentz force for several CoSi_2/Si films has been measured in perpendicular magnetic fields $|B| \leq 2$ T and at low temperatures. The MR shows a parabolic dependence on B (not shown), typical of a diffusive normal metal. Through the expression $\Delta R(B)/R(0) = [R(B) - R(0)]/R(0) = (e\tau_e B/m^*)^2$, one can also calculate the τ_e value. The inferred τ_e values are



FIG. 4. Variation of resistivity with temperature for TiSi₂/Si and NiSi₂/Si films. (a) ρ versus *T* for four 125-nm thick TiSi₂/Si(100) films underwent different thermal annealing conditions and with different electron-beam lithographic patterned width (*W*): 800°C, 1 h, *W* = 250 µm (blue), 800°C, 1 h, *W* = 4.0 µm (green), 800°C, 1 h, *W* = 0.4 µm (black), and 750°C, 1.5 h, *W* = 0.4 µm (red). Inset: $\rho(T)$ below 3 K. (b) ρ versus log(*T*) for four NiSi₂/Si(100) films with differing thickness. Films were annealed at 800°C for 1 h.

about a factor of ~ 1.7 longer than those calculated from the measured ρ_0 and n values mentioned above. This can be (partly) ascribed to the fact that a perpendicular B field mainly probes the motion of charge carriers in the film plane. The estimates extracted from the ρ_0 and n (*i.e.*, the Hall effect) method and the classical MR method are based on the free-electron gas singleband model, so such a discrepancy is not unexpected. In the present work, the relevant electronic parameters are based on n inferred from the Hall effect [37].

Resistivity of TiSi₂/Si and NiSi₂/Si films. TiSi₂ and NiSi₂ are nonmagnetic metals [24, 29]. Figure 4(a) and 4(b) show the resistivity as a function of temperature for four TiSi₂/Si films and four NiSi₂/Si films, respectively. The two figures indicate that both disilicides have $\rho(T)$ monotonically decreasing with decreasing T, reaching a residual resistivity at low temperatures. The inset of Fig. 4(a) clearly shows that the TiSi₂/Si films remain non-superconducting down to at least 50 mK. Thus, this film material can serve as an excellent counterpart for fabricating transparent CoSi₂/TiSi₂ S/N heterojunctions for the phase-sensitive conductance spectroscopy studies to probe the unconventional pairing symmetry, as emphasized above. Figure 4(b) shows ρ versus log(T) for four NiSi₂/Si films with differing thickness. We notice that these films have ρ_0 values about one order of magnitude larger than those in CoSi₂/Si and TiSi₂/Si films, indicating that they are relatively disordered. Thus, they are convenient for the measurements of spin-orbit scattering time (τ_{so}) through the quantum-interference effects. The log(T) scale of the abscissa in Fig. 4(b) makes it clear to see that NiSi₂/Si films do not undergo a superconducting transition at least down to 0.3 K.

Our estimates of the relevant electronic parameters for the C54 phase TiSi₂/Si films are as follows: $n \approx 3 \times 10^{29} \text{ m}^{-3}$ [30], $m^* \approx m_e$, $k_F \approx 2 \times 10^{10} \text{ m}^{-1}$, $v_F \approx 2 \times 10^6 \text{ m/s}$, and the product $\rho_0 l_e \approx 2.8 \times 10^{-16} \Omega \text{ m}^2$. Our corresponding estimates for NiSi₂/Si films are: $n \approx 1.7 \times 10^{28} \text{ m}^{-3}$ (from the Hall effect measurements), $m^* \approx m_e$, $k_F \approx 8 \times 10^9 \text{ m}^{-1}$, $v_F \approx 9 \times 10^5 \text{ m/s}$, and the product $\rho_0 l_e \approx 2 \times 10^{-15} \Omega \text{ m}^2$.

B. Spin-orbit scattering time

The spin-orbit coupling has become of fundamental importance in condensed matter and quantum materials science. It plays a vital role in low-dimensional systems and heterostructures and can be relevant for producing unconventional superconducting states [3, 38, 39]. The ability to manipulate quantum states through SOC engineering may have future applications in spintronics and quantum-information technology [40]. In diffusive metals, the strength of SOC increases with increasing atomic number (Z) and growing degree of disorder, i.e., the spin-orbit scattering rate is predicted to obey the relation $\tau_{so}^{-1} \simeq (\alpha Z)^4 / \tau_e$ [41], where $\alpha \simeq 1/137$ is the finestructure constant. This conventional wisdom suggests that the SOC is strong in disordered metals containing heavy impurities such as Au, Pt and Bi. In CoSi₂/Si films, as will be discussed below, the SOC is large but the films are comprised of comparatively light elements. Thus, an extrinsic mechanism is required to account for the large observed SOC. From the low-velocity limit of the Dirac equations, one has for the SOC coupling term $H_{\text{soc}} = \frac{[\nabla V(\vec{r}) \times \vec{k}] \cdot \vec{S}}{2m_e c^2}$, where V is the electron potential, \vec{k} its momentum, and \vec{S} describes the spin degree of freedom. Thus, if the potential gradient at the interface between $CoSi_2$ and Si in $CoSi_2/Si$ films is large, a sizeable SOC interaction is generated. The large SOC in $CoSi_2/Si$ films has thus been attributed to the Rashba SOC [42].

The τ_{so}^{-1} values of a series of $\text{CoSi}_2/\text{Si}(100)$ films and a series of $\text{CoSi}_2/\text{Si}(111)$ films have been quantitatively extracted from the quantum-interference weakantilocalization (WAL) studies. It is well established that in the strong SOC limit $\tau_{so}^{-1} > \tau_{\varphi}^{-1}$, where τ_{φ} is the electron dephasing time, the WAL effect results in a positive MR in low *B* fields in a weakly disordered metal. On the other hand, in the opposite limit of weak SOC



FIG. 5. Weak-antilocalization MR and spin-orbit scattering rate of CoSi_2/Si films. (a) Normalized MR, $\Delta R(B)/R(0)$, for four CoSi_2/Si films in perpendicular magnetic fields. (b) $\Delta R(B)/R(0)$ in low *B* fields for a 52.5-nm thick $\text{CoSi}_2/\text{Si}(100)$ film at four *T* values. The solid curves are least-squares-fit to the WAL theory predictions. (c) τ_{so}^{-1} versus τ_e^{-1} for a series of $\text{CoSi}_2/\text{Si}(100)$ films and a series of $\text{CoSi}_2/\text{Si}(111)$ films. The straight solid line is a linear fit. (d) τ_{so}^{-1} as a functions of *t*.

 $(\tau_{so}^{-1} < \tau_{\varphi}^{-1})$, a negative MR in low *B* fields is expected from the weak-localization effect [36].

Figure 5(a) shows the normalized MR, $\triangle R(B)/R(0) =$ [R(B) - R(0)]/R(0), for four CoSi₂/Si films measured in the normal state and in perpendicular B fields, *i.e.*, B is applied perpendicular to the film plane. In the relatively large B field regime $(B \gg B_{\varphi} = \hbar/4eD\tau_{\varphi}^2)$, a parabolic MR background resulting from the classical Lorentz force is seen. What is more important is the notable positive MR in the low B field regime $(B \leq B_{\varphi})$, which manifests the WAL effect and provides direct evidence for strong SOC in $CoSi_2/Si$ films. Figure 5(b) shows the low-B field MR for a 52.5-nm thick $CoSi_2/Si(100)$ film measured at four T values. The solid curves are least-squares fits to the theoretical predictions of Hikami *et al.* [43], taking the superconducting fluctuation effect into account [44]. Good agreement between theory and experiment is obtained. Thus, the temperature-dependent $\tau_{\omega}(T)$ and the temperature insensitive τ_{so} can be reliably extracted for

each film.

Figure 5(c) shows the variation of the extracted τ_{so}^{-1} with elastic electron scattering rate τ_e^{-1} for a series of $\text{CoSi}_2/\text{Si}(100)$ films and a series of $\text{CoSi}_2/\text{Si}(111)$ films. This figure indicates that τ_{so} is extremely short, falling between 0.2 and 0.8 ps, depending on the τ_e^{-1} value. Inspection of Fig. 5(c) reveals that, for a given τ_e^{-1} value, the τ_{so}^{-1} value is essentially the same for films grown on Si(100) and Si(111) substrates. Moreover, the figure reveals an approximately linear variation $\tau_{so}^{-1} \propto \tau_e^{-1}$, suggesting that the SOC is leading to spin relaxation through the Elliott-Yafet process [45]. The underlying origin for the strong spin-orbit interaction is most likely the Rashba SOC mechanism induced by the broken inversion symmetry at the sharp and strain-free CoSi_2/Si interface as suggested in Ref. [42]. In fact, in our CoSi_2/Si films, the ratio l_e/t gradually increases from ≈ 1 to ≈ 2.2



FIG. 6. Normalized MR, $\triangle R(B)/R(0)$, for a 63-nm thick NiSi₂/Si(100) film in perpendicular *B* fields and at four *T* values. The solid curves are the WAL theory predictions.

TABLE I. Relevant parameters for spin-orbit scattering time τ_{so} in CoSi₂/Si and NiSi₂/Si films with $t \geq 10$ nm. Values for representative Al films (taken from [46]), Cu and Au films (taken from [47]), and Ti_{73-x}Al₂₇Sn_x ($0 \leq x \leq 5$) alloys (taken from [48]) are listed for comparison. Z is the atomic number, ρ_0 the residual resistivity, and τ_e the elastic mean free time. For the disilicides, the listed Z value is the average value [Z(Cu,Ni)+Z(Si)]/3. For the Ti-Al-Sn alloy, the listed Z value is an average value over the composition.

Films	Z	$ ho_0 \left(\mu \Omega \mathrm{cm} ight)$	$\tau_e (\mathrm{fs})$	$\tau_{so} (\mathrm{ps})$
CoSi ₂ /Si	≈ 18	$\approx 2 - 10$	$\approx 8-55$	$\approx 0.2-0.8$
$NiSi_2/Si$	≈ 19	$\approx 32-64$	$\approx 3.5 - 6.4$	$\approx 10 – 30$
Al	13	$\approx 1.3 5.9$	\approx 5–20	$\approx 20 - 100$
Cu	29	$\approx 1.6 – 5.0$	$\approx 6 - 19$	$\approx 10 – 30$
Au	79	≈ 2.5	≈ 20	≈ 0.5
$\mathrm{Ti}_{73-x}\mathrm{Al}_{27}\mathrm{Sn}_x$	≈ 20	≈ 225	≈ 0.1	$\approx 3-20$

as t decreases from 105 nm to 5 nm (not shown), suggesting that surface and interface scattering dominates over the bulk defect scattering. This is illustrated in Figure 5(d) which shows a plot of τ_{so}^{-1} versus t. An increase of τ_{so}^{-1} with decreasing t, *i.e.*, increasing CoSi₂/Si interface scattering, especially at $t \leq 20$ nm is evident. This finding further supports the interface-induced Rashba SOC scenario [8, 42]. Further experimental and theoretical studies to address this issue are desirable.

For comparison, the spin-orbit scattering time for four NiSi₂/Si(111) films with t in the range 36 to 63 nm, corresponding to ρ_0 varying from 64 down to 32 $\mu\Omega$ cm, has also been measured through the WAL effect. Figure 6 shows the results for a representative film. We obtain $\tau_{so} \approx (10\text{--}30)$ ps, being more than one order of magnitude longer than that in CoSi₂/Si films, even though these NiSi₂/Si films are more disordered than CoSi₂/Si films, see Table I.

Table I also listed the τ_{so} values for several typical polycrystalline Al films [46], Cu and Au films [47] and $\operatorname{Ti}_{73-x}\operatorname{Al}_{27}\operatorname{Sn}_x (0 \le x \le 5)$ alloys [48] taken from the literature. The ρ_0 and τ_e values of these elementary metal and disilicide (except NiSi₂/Si) films listed in Table I are on the same order of magnitude. However, the τ_{so} value of $CoSi_2/Si$ films is much shorter than that in the other (except Au) films. That is, $\tau_{so}(\text{CoSi}_2/\text{Si})$ is about two orders of magnitude shorter than those in Al, Cu and NiSi₂/Si films. Surprisingly, even in the very high ρ_0 (\simeq 225 $\mu\Omega$ cm) Ti_{73-x}Al₂₇Sn_x alloys where l_e approaches the interatomic spacing, its τ_{so} value is still more than one order of magnitude larger than that in $CoSi_2/Si$ films. It is also intriguing that the SOC rate in $CoSi_2/Si$ films is comparable with that in a heavy Au film, especially considering that Z(Au) is much larger than $Z(CoSi_2/Si)$. The above results strongly point out that, in many cases, the simple relation $\tau_{so}^{-1} \propto Z^4/\tau_e$ does not apply across different metals and alloys containing (heavy) impurities [49].

While $\tau_{so}^{-1}(\text{CoSi}_2/\text{Si}) \gg \tau_{so}^{-1}(\text{Al})$, the two materials have very similar T_c and $riangle_0$ values. In other words, the ratios of the SOC energy (\hbar/τ_{so}) to Δ_0 are significantly different in CoSi₂/Si films and Al films. In the former, $(\hbar/\tau_{so})/\Delta_0 \sim 15$, and in the latter, $(\hbar/\tau_{so})/\Delta_0 \sim 0.1$. For the (seven) Al films listed in Table 1, $T_c \approx 1.4$ K. $\tau_{so} \approx 20\text{-}100$ ps. The ratio $(\hbar/\tau_{so})/\triangle_0 \approx 0.03\text{-}0.2$. For the CoSi_2/Si film with the shortest $\tau_{so} \approx 0.2$ ps and the lowest $T_c \approx 1.15$ K, $\hbar/\tau_{so} \approx 3.5$ meV, and $(\hbar/\tau_{so})/\triangle_0 \approx$ 20. In Ref. [7] we used the classical MR to evaluate the electronic parameter. In this work, we have measured the Hall effect and started with the evaluated n value (through a single-band free-electron-gas model) to calculate the electronic parameters, see subsection III.A. This leads to the ratio $(\hbar/\tau_{so})/\Delta_0$ a factor ~ 1.5 smaller than that (≈ 30) in Ref. [7].

Generation of two-component superconductivity. The $CoSi_2$ band structure may be substantially modified in CoSi₂/Si films due to the confined geometry and changes in the chemical environment. On top of these changes, the interface generates a SOC term $H_{\text{SOC}} = \frac{[\nabla V(\vec{r}) \times \vec{k}] \cdot \vec{S}}{2m_e c^2} \sim \vec{\mathcal{A}}(k) \cdot \vec{\sigma}$ with $|\vec{\mathcal{A}}(k)| = 1$, as briefly discussed above. Here, $\vec{\mathcal{A}}(k) = (k_y, -k_x, 0)$, and $\vec{\sigma}$ is a vector of Pauli spin matrices $(\sigma_x, \sigma_y, \sigma_z)$. This leads to splitting the otherwise spin-degenerate bands into two helical bands. The SOC energy is generally minimal compared to the Fermi energy but, as it turns out, is large in CoSi₂/Si films compared to the characteristic energy Δ_0 of the superconducting state. Revisiting the BCS pairing problem in the presence of this SOC term, one obtains a gap structure $\hat{\Delta} = (\Delta_s + \Delta_t \vec{\mathcal{A}} \cdot \vec{\sigma}) i \sigma_y$ [50]. If one compares with the general gap structure $\hat{\Delta} = \Delta_s i \sigma_y + \Delta_t \vec{d} \cdot \vec{\sigma} i \sigma_y$, it becomes clear that the SOC interaction leads to an order parameter that possesses both spin-singlet (Δ_s) and spin-triplet (Δ_t) component. The

SOC vector $\vec{\mathcal{A}}$ acts as the spin vector \vec{d} -vector [42, 51]. The effect of a superconductor with strong SOC in place of the *s*-wave or *p*-wave superconductor of a T-shaped proximity structure was analyzed in Ref. [42]. As it turns out, the resulting conductance spectrum can feature a sharp peak as in Fig. 1(d) for a wide parameter range where the spin-triplet component dominates. The conductance spectrum will interpolate between the spinsinglet and spin-triplet cases illustrated in Fig. 1(c) as a function of the relative weight of the two components [42].

C. Electron dephasing length

In addition to $\tau_{so},$ the electron dephasing time τ_{φ} can also be extracted from the WAL measurements. Figure 7(a) shows the electron dephasing length $L_{\varphi} = \sqrt{D\tau_{\varphi}}$ as a function of T for four CoSi_2/Si films. The WAL effect is measured only down to 4 K to minimize (but still not totally eliminate) the superconducting-fluctuation-effect induced positive MR [44]. The solid curves are leastsquares fits with the total dephasing rate expressed by $\tau_{\varphi}^{-1} = \tau_{ee}^{-1} + \tau_{ep}^{-1} = A_{ee}T + A_{ep}T^3$ [36], where the first term on the right-hand side of the equation is the twodimensional electron-electron scattering rate, and the second term is the electron-phonon scattering rate. For the two 52.5-nm thick films with $\rho_0 \approx 3.0 \ \mu\Omega$ cm, we obtain approximate values of $A_{ee} \approx 3.6 \times 10^9 \ {\rm s}^{-1} \, {\rm K}^{-1}$ and $A_{ep} \approx 4.6 \times 10^7 \ {\rm s}^{-1} \, {\rm K}^{-3}$. For the two 24.5-nm thick films with $\rho_0 \approx 4.5 \ \mu\Omega$ cm, we obtain approximate values of $A_{ee} \approx 1.0 \times 10^{10} \ {\rm s}^{-1} \, {\rm K}^{-1}$ and $A_{ep} \approx 3.3 \times 10^7 \ {\rm s}^{-1} \, {\rm K}^{-3}$. Here the A_{ep} values are about a factor of ~ 2.5 higher than that in those Al films studied in Ref. [46]. The information about τ_{ep}^{-1} will be useful for understanding the quasiparticle dissipation problem in the superconducting devices made of CoSi₂/Si films.

We note that Fig. 7(a) reveals a long L_{φ} exceeding 1 μ m already at 4 K for films with t > 50 nm. We also would like to point out that, taken together, (1) the long L_{φ} , (2) a high T_c accompanied by a sharp superconducting transition [Fig. 2(b)], and (3) the SQUID magnetization measurement results [7], complementarily suggest that our CoSi₂/Si films are nonmagnetic. For comparison, we note that our measured L_{φ} values are much longer than those previously reported by DiTusa *et al.* in their CoSi₂ epitaxial films, where the authors ascribed their short L_{φ} to the contamination of magnetic impurities and possibly small departure from stoichiometry at the film/substrate interface [52].

Figure 7(b) shows L_{φ} as a function of T for four NiSi₂/Si(100) films. Because these films do not become superconducting, we can measure the WAL MR and extract L_{φ} down to sub-kelvin temperatures. The solid



FIG. 7. Electron dephasing length $L_{\varphi} = \sqrt{D\tau_{\varphi}}$ as a function of log(*T*) for (a) four CoSi₂/Si films, and (b) four NiSi₂/Si films. The solid curves in (a) and (b) are least-squares fits with the total electron dephasing rate τ_{φ}^{-1} as an adjusting parameter (see text).

curves are least-squares fits with the total dephasing rate $\tau_{\varphi}^{-1} = A_0 + A_{ee}T + A_{ep}T^p$ [36], where the additional term on the right-hand side of the equation is a constant, called the "saturated dephasing rate" and given by $A_0 = \tau_{\varphi}^{-1}(T \to 0)$, and p is a temperature exponent for the electron-phonon scattering. For example, for the 63-nm thick film with $\rho_0 \approx 32 \ \mu\Omega$ cm, we obtain $A_0 \approx 2.9 \times 10^8 \text{ s}^{-1}$, $A_{ee} \approx 3.3 \times 10^8 \text{ s}^{-1} \text{ K}^{-1}$ and $A_{ep} \approx 6.0 \times 10^8 \text{ s}^{-1} \text{ K}^{-p}$, with $p \approx 2.8$. Figure 7(b) reveals a L_{φ} reaching 2 μ m at low T, suggesting that this disilicide can be an appealing material candidate for making quantum-interference devices. Our extracted L_{φ} values are in good accord with those previously reported by Matsui *et al.* in single-crystal NiSi₂ films [53].

D. Low frequency 1/f noise

The low-frequency (flicker) 1/f noise in a conductor is empirically described by the Hooge relation S_V = $\gamma V_s^2/N_c f^\beta + S_V^0$, where S_V is the measured voltage noise power spectrum density (PSD), γ is a dimensionless parameter characterizing the magnitude of the noise, V_s is the bias voltage drop on the sample, N_c is the total number of charge carriers in the conductor, f is the frequency, and the exponent $\beta \approx 1$ for a wide variety of conductors [54]. S_V^0 is the background noise of the measurement circuit, which is limited by the Johnson-Nyquist noise and the input noise $\approx 1.7 \times 10^{-17} \text{ V}^2/\text{Hz}$ of our preamplifier (Stanford Research Systems model SR560). The underlying origin of the 1/f noise is usually modeled by the twolevel systems which are taken to be dynamical structural defects, such as a small group of moving atoms, oxygen vacancies, dangling bonds, nanometer-sized grains, etc. [55, 56] For any practical nanoelectronic and superconducting devices to achieve the ultimate performance, it is highly desired that the 1/f noise level of the device be as low as possible.

 $CoSi_2/Si$ films have the advantage that the calcium fluoride (CaF₂) crystal structure of $CoSi_2$ has strong co-



FIG. 8. Normalized low-frequency noise $N_c S_V / V_s^2$ versus f of a 105-nm thick $\text{CoSi}_2/\text{Si}(111)$ film with $\rho(300 \text{ K}) = 17 \ \mu\Omega$ cm and a 30-nm thick Al film with $\rho(300 \text{ K}) = 5.5 \ \mu\Omega$ cm at T = 300 K. The bias voltage was ≈ 146 mV (≈ 131 mV) for the CoSi_2/Si (Al) film. The straight dashed lines are drawn proportional to f^{-1} and is guide to the eye.

valent bonding. Moreover, as mentioned, the lattice mismatch between CoSi_2 and silicon is minimal. This small lattice mismatch makes favorably the epitaxial growth of CoSi_2 on both Si(100) and Si(111) substrates, resulting in very few dangling bonds at the interface. Thus, CoSi_2/Si films are fairly stable in the ambient and expected to have an ultralow level of 1/f noise [27].

Figure 8 shows the variation of the normalized lowfrequency noise $N_c S_V / V_s^2$ with f for a 105-nm thick $CoSi_2/Si(111)$ film and a 30-nm thick polycrystalline Al film at T = 300 K. The Al film was deposited via electrongun evaporation. A $1/f^{\beta}$ dependence with $\beta \simeq 1$ (as indicated by the straight dashed lines) is seen already at $f \leq f$ 30 Hz in the Al film, while it only appears at very low frequencies $f \leq 0.3$ Hz in the CoSi₂/Si(111) film. This is a direct manifestation of the fact that the excess 1/f noise is minimal and buried in the background noise S_V^0 until at very low frequencies. We have measured the $S_V \propto V_s^2$ dependence in both Al and $CoSi_2/Si(111)$ films and determined the γ values from the slope. The extracted $\gamma(300\,\mathrm{K}) \approx (5\pm3) \times 10^{-6}$ for the $\mathrm{CoSi}_2/\mathrm{Si}(111)$ film is very small and in line with our previous result of $\gamma(150 \text{ K})$ $\approx 3 \times 10^{-6}$ in another 105-nm thick $\text{CoSi}_2/\text{Si}(100)$ film [27]. This value is three orders of magnitude lower than the extracted $\gamma(300\,\mathrm{K}) \approx (5\pm2) \times 10^{-3}$ in the polycrystalline Al film (Fig. 8) and two orders of magnitude lower



FIG. 9. Superconducting transition temperature T_c as a function of t for a series of $\text{CoSi}_2/\text{Si}(100)$ films and a series of $\text{CoSi}_2/\text{Si}(111)$ films. The solid curve is a guide to the eye. The two blue down triangles represent the T_c values for arcmelted polycrystalline CoSi_2 bulks (cf. Fig. 12).

than that in single-crystalline Al films grown on sapphire substrate [57, 58]. We note that, for typical metals and alloys, $\gamma \approx 10^{-4}$ – 10^{-2} [55, 56]. Our observation of ultralow 1/f noise suggests that CoSi₂/Si films have a high potential for use as building blocks for superconducting circuits and quantum devices.

IV. SUPERCONDUCTING PROPERTIES

In this section, we discuss the variation of superconducting properties with the thickness of $\operatorname{CoSi}_2/\operatorname{Si}$ films. The superconducting transition temperature T_c as well as the upper critical fields $B_{c2,\perp}$ and $B_{c2,\parallel}$ measured in magnetic fields applied perpendicular and parallel to the film plane, respectively, will be discussed. The Ginzburg-Landau coherence length $\xi_{\operatorname{GL}}(T)$ in the film plane can be inferred from the measured $B_{c2,\perp}(T)$ value. The penetration depth $\lambda(T \to 0)$ in the BCS theory is calculated. We will remark on the potential applications of $\operatorname{CoSi}_2/\operatorname{Si}$ films as superconducting microwave resonators. The critical current density of films as well as the superconducting properties of polycrystalline CoSi_2 bulks will be briefly discussed.

A. Variation of superconducting transition temperature with film thickness

The superconducting transition temperature T_c of a series of CoSi₂/Si films grown on Si(100) substrates and a series of CoSi₂/Si films grown on Si(111) substrates have been measured. The variation of T_c with CoSi₂/Si

film thickness t is shown in Fig. 9. This figure indicates that the T_c value for a given t is essentially the same for both series of films, independent of the Si(100) and Si(111) substrate direction. Moreover, the T_c value (\simeq 1.45 ± 0.1 K) remains essentially unchanged for films with $t \gtrsim 35$ nm. As t decreases from 35 nm down to 7 nm, the T_c value gradually decreases from ≈ 1.4 K to ≈ 1.2 K. The thinnest films which still become superconducting have a thickness $t \simeq 5$ nm and a transition temperature $T_c \simeq (1.0-1.2)$ K. We have also fabricated a 3.5-nm thick $CoSi_2/Si(111)$ film, which has a fairly high residual resistivity $\rho_0 = 56.3 \ \mu\Omega$ cm and a superconducting onset temperature ≈ 0.6 K. A zero-resistivity state was not reached down to 0.36 K. For comparison, we note that in the early work by DiTusa *et al.* [52], the T_c value of their 20-nm (12-nm) thick $CoSi_2$ epitaxial films prepared using ultrahigh vacuum techniques already dropped to 1.06 K (< 0.57 K). Our higher T_c values compared with theirs (of similar t) suggest the reliability of our fabrication method and the high quality of our as-grown films.

With the residual resistivity ρ_0 (equivalently, the sheet resistance $R_{\Box} = \rho_0/t$) and the T_c value available as a function of t [Fig. 3(c) and Fig. 9], one may design and grow patterned CoSi₂/Si films by modifying the thickness and geometry to adjust, *e.g.*, the kinetic inductance (L_K) of a microwave resonator for a specific superconducting circuit. Approximately, $L_K \propto (L/W)(R_{\Box}/\Delta_0)$ as $T \to 0$ [34, 59], where L and W are the length and width of the resonator, respectively.

B. Upper critical fields

We have measured the upper critical fields in perpendicular and parallel directions for a series of CoSi_2/Si films. Figure 10(a) shows the normalized resistance, R(B)/R(B=0.3 T), as a function of magnetic field for a representative 105-nm thick $\text{CoSi}_2/\text{Si}(100)$ film in perpendicular *B* fields and at several *T* values. We define the critical field as the field where the sample resistance deviates from zero. The variation of $B_{c2,\perp}$ with *T* can be determined from this figure. Similarly, $B_{c2,\parallel}(T)$ can be measured in parallel *B* fields.

Figure 10(b) shows the perpendicular and parallel upper critical fields as a function of temperature for the film shown in Fig. 10(a). As expected for a superconducting film [60], it is clearly seen that $B_{c2,\perp}$ obeys a linear T dependence which can be expressed by $B_{c2,\perp}(T) = B_{c2,\perp}(0)(1 - T/T_c)$, while $B_{c2,\parallel}$ obeys a square-root-T dependence which can be expressed by $B_{c2,\parallel}(T) = B_{c2,\parallel}(0)(1 - T/T_c)^{1/2}$. For this film, we obtain the extrapolated zero temperature fields $B_{c2,\perp}(0) =$ 0.033 T and $B_{c2,\parallel}(0) = 0.10$ T. The upper critical fields of several films are listed in Table II.

Ginzburg-Landau coherence length. We have evaluated the superconducting coherence length $\xi_{GL}(T)$



FIG. 10. Upper critical fields of a 105-nm thick $\text{CoSi}_2/\text{Si}(100)$ film. (a) Normalized resistance R(B)/R(0.3 T) versus perpendicular *B* field at several *T* values. (b) Perpendicular and parallel upper critical fields versus reduced temperature T/T_c $(T_c = 1.534 \text{ K})$. The straight solid line and the solid curve through $B_{c2,\perp}$ and $B_{c2,\parallel}$, respectively, are least-squares fits (see text).

in the film plane from the perpendicular upper critical field through the Ginzburg-Landau relation $B_{c2,\perp}(T) = \phi_0/2\pi\xi_{\rm GL}^2(T)$, where $\phi_0 = h/2e$ is the flux quantum. Our extracted values for $\xi_{\rm GL}$ as $T \to 0$ K are listed in Table II. Inspection of Table II indicates that $\xi_{\rm GL}(T \to 0)$ gradually decreases from 100 nm to 81 nm as the CoSi₂/Si film thickness decreases from 105 to 7 nm, insensitive to Si substrate orientation. For all films studied in this work, the extracted coherence length is longer than the elastic carrier mean free path, *i.e.*, $\xi_{\rm GL}(T \to 0) > l_e$. Similarly, the superconducting coherence length in the direction normal to the film plane, $\xi_{\perp}(T)$, can be evaluated through the Ginzburg-Landau relation $B_{c2,\parallel} = \phi_0/(2\pi\xi_{\rm GL}\xi_{\perp})$, see Table II.

Penetration depth. The London penetration depth in the clean limit can be evaluated from the Ginzburg-Landau expression: $\lambda_{\rm L}(0) = \sqrt{\tilde{m}/(\mu_0 \tilde{n}_s \tilde{e}^2)}$, where \tilde{m} (\tilde{e}) is the mass (charge) of a Cooper pair, \tilde{n}_s is the density of Cooper pairs, and μ_0 is the permeability of free space. We obtain $\lambda_{\rm L}(0) \simeq 38$ nm, with $\tilde{n}_s \simeq 1 \times 10^{28} {\rm m}^{-3}$. When the elastic carrier mean free path has a finite value, the penetration depth is modified and the BCS theory predicts $\lambda(T=0) = \lambda_{\rm L}(0)\sqrt{1+\xi_0/l_e}$, where $\xi_0 = \hbar v_F/\pi \Delta_0$ is the coherence length in the BCS theory [61]. For example, for our 105- (24.5-) nm thick $CoSi_2/Si$ film, we estimate a value $\lambda(0) \simeq 140$ (220) nm, see Table II. These evaluations of $\lambda(0)$ may be subject to some uncertainties. Nevertheless, it should be safe to conclude that the $CoSi_2/Si$ films are type II superconductors. They fall deeper in the type-II regime when the films are made thinner. Experimentally, values of $\lambda(T \to 0)$ may be inferred from the measurements of effective microwave surface impedance by employing a resonator technique [62] or measurements of the vortex inductance in a type II superconductor [63]. These will be addressed in future work.

In a spin-singlet superconductor, the $B_{c2}(T \to 0)$ cannot exceed the Pauli or Clogston–Chandrasekhar paramagnetic limit, which in the BCS theory is given by $(B_{c2})_{\text{Pauli}} = 1.84 T_c$, where B_{c2} is in T and T_c is in K [61].

TABLE II. Relevant parameters for five representative CoSi_2/Si films. t is the film thickness, T_c is the superconducting transition temperature, ρ_0 is the residual resistivity, l_e is the elastic mean free path, $B_{c2\perp}$ ($B_{c2,\parallel}$) is the perpendicular (parallel) upper critical field, ξ_{GL} is the Ginzburg-Landau coherence length in the film plane, and $\lambda(0)$ is the penetration depth at T = 0. The listed $B_{c2,\perp}$, $B_{c2,\parallel}$ and ξ_{GL} values were those extrapolated as $T \to 0$. The $\lambda(0)$ values were calculated from the BCS theory (see text).

t (nm)	Si	$T_{c}\left(\mathrm{K}\right)$	$ ho_0 \left(\mu \Omega { m cm} ight)$	$l_e (\mathrm{nm})$	$B_{c2,\perp}(\mathrm{T})$	$B_{c2,\parallel}$ (T)	$\xi_{ m GL}(m nm)$	$\lambda(0) (\mathrm{nm})$
105	(100)	1.54	2.5	67	0.033	0.10	100	140
52.5	(100)	1.35	3.5	48	0.032	—	100	170
35	(111)	1.18	4.3	39	0.040	0.22	91	200
24.5	(100)	1.25	5.5	30	0.044	_	87	220
7	(111)	1.15	11	15	0.050	0.78	81	330

For a *p*-wave superconductor, the possible phases are distinguished by the spin vector \vec{d} . The value of B_{c2} at zero temperature varies for each phase. The polar phase, which is formed by Cooper pairs having $S_z = 0$ (spin) and m = 0 (orbital) angular momentum, has the highest B_{c2}

C. Superconducting critical current density

We have measured the superconducting critical current density (J_c) for several CoSi₂/Si films in zero magnetic field. Figure 11(a) shows the variation of J_c with T for three 91-nm and one 105-nm thick films, as indicated. The solid curve through one of the samples (red circles) is the least-squares fit to the phenomenological expression: $J_c(T) = J_c(0) \tanh[b\sqrt{(T_c/T-1)}]$, where b is a dimensionless parameter of the order of Δ_0/k_BT_c , and k_B is the Boltzmann constant [67]. Good agreement is obtained, with extrapolated $J_c(T=0) = 0.41 \text{ mA}/\mu\text{m}^2$. We have also measured a 21-nm thick and $1.3-\mu m$ wide $\text{CoSi}_2/\text{Si}(111)$ microbridge with $\rho_0 = 5.4 \ \mu\Omega$ cm, see Fig. 11(b). The measured $J_c(0.26 \text{ K}) \simeq 0.38 \text{ mA}/\mu\text{m}^2$ in B =0 (black symbols) is close to that shown in Fig. 11(a). In a perpendicular magnetic field B = 0.2 T (red straight line), the microbridge returns to the normal state.

D. Superconducting microwave resonators

Superconducting microwave resonators have versatile and indispensable applications in qubit readout [68], qubit-qubit coupling [69], quantum memory [70], and sensitive photon detectors [71], etc. These emergent applications have inspired intense efforts on the search for novel material candidates and fabrication techniques to implement high-performance superconducting devices. In practice, the performance of superconducting microwave resonators is deemed to be hampered by the loss value. It surpasses the Pauli or Clogston–Chandrasekhar paramagnetic limit [64, 65]. For the two-component superconductivity, the breaking of inversion symmetry can lead to helical phases [50] and the orientation of \vec{B} with respect to $\vec{\mathcal{A}}$ matters [42, 66]. Experiments exploring the anisotropy of $\vec{B}_{c2}(T)$ are currently ongoing.



FIG. 11. (a) Superconducting critical current density J_c versus T for four CoSi₂/Si films. The solid curve through the red circles is a least-squares fit to the 91-nm thick and 3.74- μ m wide CoSi₂/Si(100) film. (b) J-V curves for a CoSi₂/Si(111) microbridge measured in zero B field and in a perpendicular field B = 0.2 T.

and low frequency 1/f noise, which are believed to arise from two-level systems. However, the detrimental twolevel systems in superconducting circuits are yet to be fully identified and categorized, and then to be removed or their number minimized [72]. In this regard, the appealing material properties of $CoSi_2/Si$ films reported in this paper, especially the ultralow 1/f noise amplitude, suggest their potential for reaching a high quality factor and small frequency noise in superconducting microwave resonators. Moreover, the spin-triplet chiral *p*-wave pairing symmetry observed in CoSi₂/TiSi₂ S/N junctions and T-shaped proximity structures aforementioned [7, 8] suggest that CoSi₂/Si films may be useful for hosting topological superconducting properties that are highly desired for the quantum computing technology [73]. Experiments in this direction are encouraged.



FIG. 12. ρ versus log(T) for three polycrystalline CoSi₂ bulk samples prepared via the arc-melting method from two source lumps.

E. Arc-melted bulk CoSi₂

For comparison, we have prepared several bulk samples by the standard arc-melting method [44] from two sources of commercial $CoSi_2$ lumps. Figure 12 shows the variation of resistivity with $\log(T)$. All samples are metallic, undergoing superconducting at low temperatures. It is clear that $\rho(T)$ of all samples approaches ρ_0 at about 40 K, a T value higher than the value where our $CoSi_2/Si$ films reach ρ_0 [cf. Fig. 3(a)]. Interestingly, for the two bulk samples (red and black symbols) having a T_c value as high as $\simeq 1.6$ K, their ρ_0 value (= 4.0 $\mu\Omega$ cm) are larger than that (1.77 $\mu\Omega$ cm) of our thickest CoSi₂/Si films [cf. Fig. 3(c)]. This result indicates that our films are really of high quality and they are nominally epitaxial [27]. The third sample (blue symbols) in Fig. 12 was arc-melted from a source lump different from that of the first two samples. This bulk sample has a relatively large ρ_0 value (close to that of a 10-nm thick CoSi_2/Si film) and a low $T_c \simeq 1.0$ K (lower than that of all our films shown in Fig. 9). The reason for such a low T_c value is due to the source lump having a low purity. The atomic emission spectroscopy studies indicate that the source lump contains magnetic and nonmagnetic impurities, including, among others, 60 ppm of Fe and 35 ppm of Ni. On the other hand, the first source lump reveals a X-ray diffraction pattern similar to that of Fig. 2(a), indicating that it is a relatively clean and single-phased $CoSi_2$. The T_c values obtained from the two clean samples are also plotted in Fig. 9 (blue down triangles).

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V. CONCLUSION

Thin films of nominally epitaxial CoSi₂ grown on silicon Si(100) and Si(111) substrates reveal unusual normal-state electrical-transport characteristics. In addition to showing typical metallic conduction with low resistivities, they process unexpectedly strong spin-orbit coupling, manifesting notable positive magnetoresistance arising from the weak-antilocalization effect. They have a long electron dephasing length exceeding 1 μ m at 4 K. They show ultralow 1/f noise, which can be attributed to the strong covalent bonding in the CoSi₂ crystal structure as well as a small lattice mismatch between $CoSi_2$ and silicon. The strong spin-orbit coupling is likely of the Rashba type, which induces two-component (s + p) superconductivity with the spin-triplet *p*-wave pairing component being dominant, as previously established from the conductance spectroscopy studies of $CoSi_2/TiSi_2$ S/N heterojunctions [7, 42] and T-shaped superconducting proximity structures [7, 8]. The long electron mean free path and ultralow 1/f noise shall benefit the potential applications of $CoSi_2/Si$ films as the building blocks of superconducting and quantum In contrast to other material candidates of devices. unconventional (topological) superconductors, which are usually bulk crystals, the growth of CoSi₂/Si films are fully compatible with the present-day silicon-based integrated-circuit technology. In particular, the stable thin-film form in the ambient allows them for micro-fabrication and patterning via the standard photo-lithographic and electron-beam lithographic technique, promising device scalability in superconducting circuits. We would like to propose that (nominally) epitaxial CoSi₂/Si/CoSi₂ Josephson junctions and CoSi₂/CoSi/CoSi₂ Josephson weak links be developed and explored, where CoSi is a topological semimetal [74, 75]. Superconducting devices based on $CoSi_2/Si$ films may open an avenue for fundamental research and applications in the emergent quantum-information technology.

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